#### T-1 (3mm) SOLID STATE LAMP

Part Number: WP710A10SEC/E Hyper Red

### **Features** Description • Low power consumption. The Hyper Red source color devices are made with Al-• Popular T-1 diameter package. GaInP on GaAs substrate Light Emitting Diode. • General purpose leads. • Reliable and rugged. • Long life - solid state reliability. • Available on tape and reel. • RoHS compliant. **Package Dimensions** 4.6(0.181)±0.3 27(1.063)MIN. 1(0.039) 1.5(0.059)TYP. ø3.2(0.126) ø2.9(0.114) CATHODE 54(0.1) ø2.8(0.11) 0.5(0.02) TMAX. 1.0MAX. പ് 5.4(0.213)±0.5 Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.25(0.01") unless otherwise noted. Lead spacing is measured where the leads emerge from the package. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAL0538 APPROVED: WYNEC REV NO: V.1 CHECKED: Allen Liu DATE: AUG/09/2010 DRAWN: Y.H.Wu PAGE: 1 OF 6 ERP: 1101029216

#### **Selection Guide** lv (mcd) [2] Viewing @ 20mA Angle [1] Part No. Dice Lens Type 201/2 Min. Тур. WP710A10SEC/E Hyper Red (AlGaInP) Water Clear 1700 2800 34°

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	630		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red	621		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	I⊧=20mA
С	Capacitance	Hyper Red	25		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Hyper Red	2.0	2.5	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	VR = 5V

Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

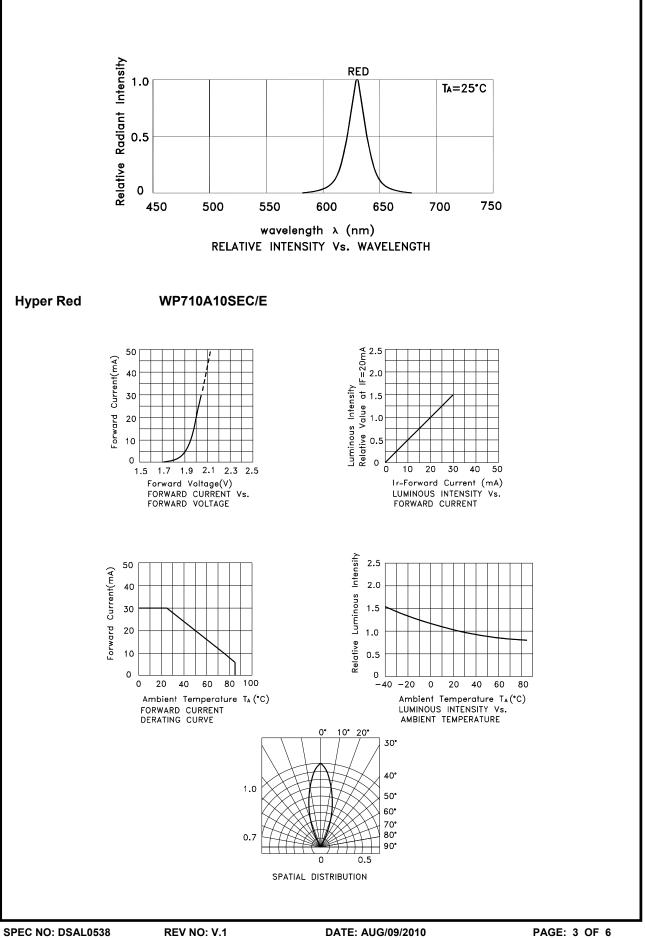
Parameter	Hyper Red			
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	195	mA		
Reverse Voltage	5	V		
Operating/Storage Temperature	-40°C To +85°C			
Lead Solder Temperature [2]	260°C For 3 Seconds			
Lead Solder Temperature [3]	260°C For 5 Seconds			

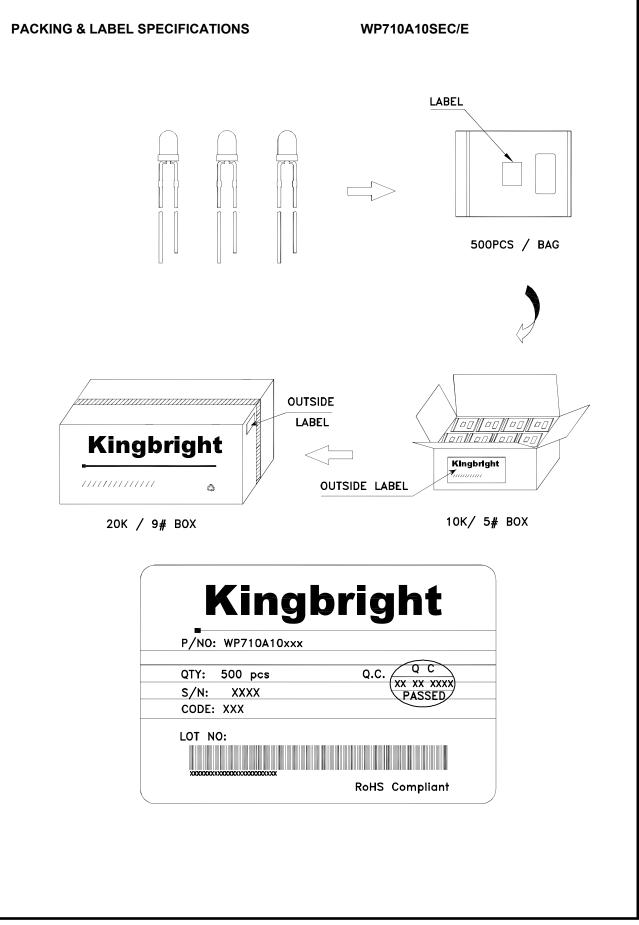
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.
3. 5mm below package base.

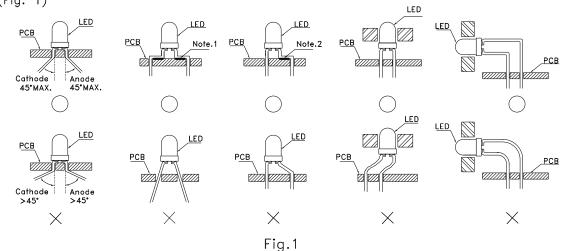
DATE: AUG/09/2010 DRAWN: Y.H.Wu





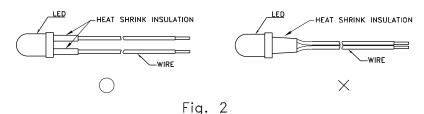
#### LED MOUNTING METHOD

 The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



" $\bigcirc$ " Correct mounting method " $\times$ " Incorrect mounting method Note 1-2 : Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig. 2)



3. Use stand-offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.

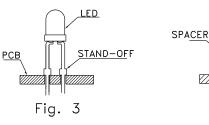


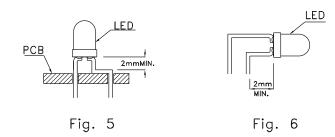
Fig. 4

LED

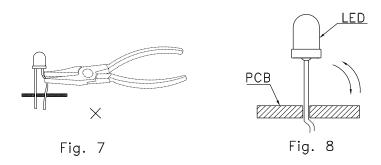
PCB

#### LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)



- 2. Lead forming or bending must be performed before soldering, never during or after Soldering.
- 3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
- 4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
- 5. Do not bend the leads more than twice. (Fig. 8)



6. After soldering or other high-temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.

